VGAP-CLK-AS-A1 Specification

1. Features and Application:

- (1) This product is manufactured in ISO/TS16949 certified production factory.
- (2) This product is qualified according to AEC-Q200.
- (3) This product is for 3-4GHz.

2. Explanation of Part Number:

$$\frac{\text{VGAP}}{\text{(1)}} - \frac{\text{C}}{\text{(1)}} \frac{\text{LK}}{\text{(2)}} - \frac{\text{A}}{\text{(3)}} \frac{\text{S}}{\text{(4)}} - \frac{\text{A1}}{\text{(5)}}$$

(1) Product Type: Chip Antenna

(2) Center Frequency/Band Code: 3 - 4 GHz

(3) Size Code: 5.0*3.6 mm (Length*Width)

(4) Special Code: RoHS Compliant

(5) Design Revision Code: Rev.1

3. Electrical Specification:

Item	Specification
Frequency Band	3000 ~ 4000 MHz
VSWR	Less than 3.5
Polarization	Linear
*Peak Gain	3.2 dBi Typ.
*Peak Efficiency	69 % Typ.
Impedance	50 ohm Typ.

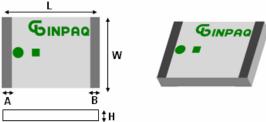
^{*} Test condition: Test board size 53*31 mm

Matching circuit may be required

UNLESS OTHER SPECIFIE	D TOLERANCES ON:				
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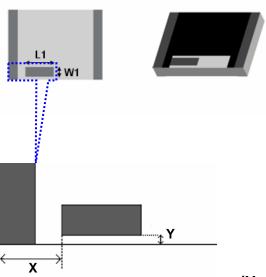
4. Physical Dimension:





Marking is Green

Bottom View



(Unit: mm)

•	Chip Antenna	L	W	Α	В	L1	W1	Н	Х	Υ
١	/GAP-CLK-AS-A1	5.2±0.3	3.7±0.3	0.45±0.25	0.45±0.25	1.55±0.20	0.55±0.20	0.70±0.15	0.85±0.25	0.12±0.06

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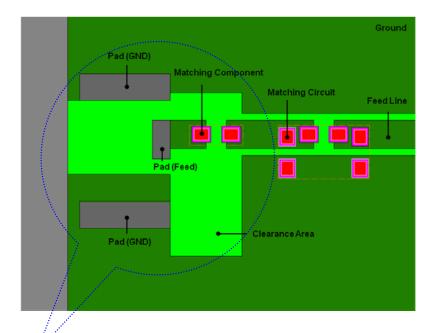
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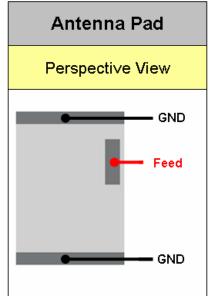
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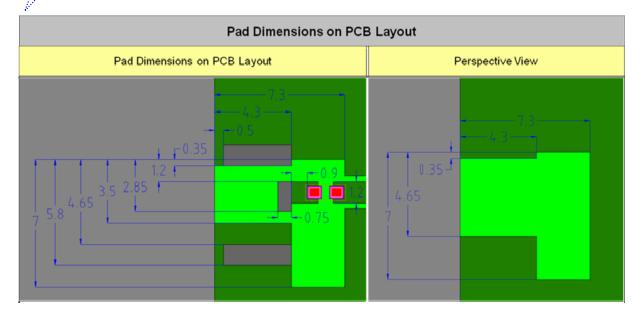
DOCUMENT	ENS000062850
NO.	EN3000062630

5. Recommend PCB Layout:





(Unit: mm)



PCB pad dimensions Tolerance: ±2

Terminal Name	Terminal Dimensions
Pad (Feed)	1.65*0.75
Pad (GND)	3.8*1.15
Pad (GND)	3.8*1.15

Antenna pad dimensions

Terminal Name	Terminal Dimensions
Feed	1.55*0.55
GND	3.7*0.45
GND	3.7*0.45

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6. Electrical Characteristics:

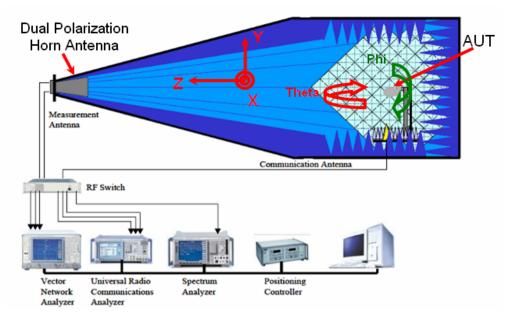
VSWR



Mark	Frequency (MHz)	VSWR
1	3000	3.4
2	3500	2.5
3	4000	2.9

Radiation Pattern

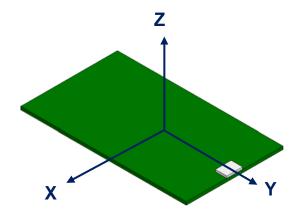
The Gain pattern is measured in INPAQ's FAR-field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.

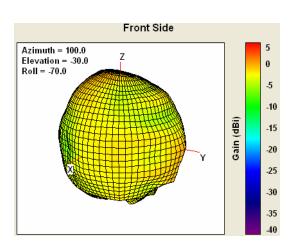


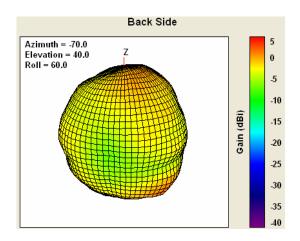
3D Chamber Definition

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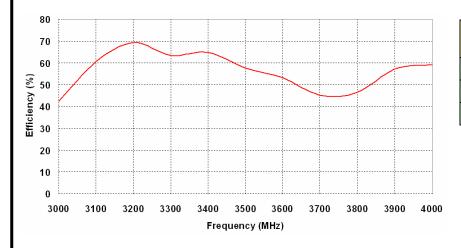
3D Gain Pattern (3500 MHz)







Efficiency



Frequency	Efficiency
(MHz)	(%)
3000	42.3
3500	57.5
4000	59.2

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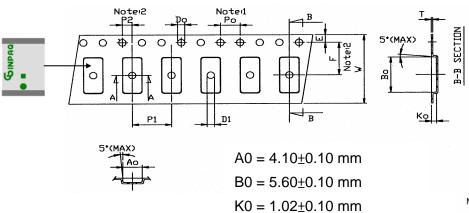
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NO.	ENS000062850	A0

7. Taping Package and Label Marking:

(1) Quantity/Reel: 2000pcs/Reel

(2) Carrier tape dimensions



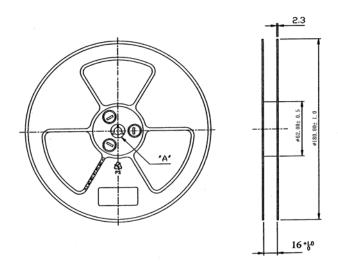
(Unit: mm)

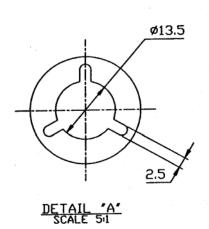
Symbol	Spec.
Ро	4.00±0.1
P1	8.00±0.1
P2	2.00±0.05
Do	1.55±0.05
D1	1.50(MIN)
Е	1.75±0.1
F	5.50±0.05
10Po	40.00±0.2
W	12.00±0.1
T	0.25±0.05

Notice:

- 10 Sprocket hole pitch cumulative tolerance is ±0.1mm
- Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.
 Ao & Bo measured on a place 0.3mm above the bottom of the pocket to top surface of the carrier.
- Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- Carrier camber shall be not than 1mm per 100mm through a length of 250mm.

(3) Taping reel dimensions





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8. Environmental Characteristics:

This product is qualified according to AEC-Q200.

(1) Reliability Test

Item	Condition	Specification
Thermal shock	 30±3 minutes at -40°C±5°C, Convert to +105°C (5 minutes) 30±3 minutes at +105°C±5°C, Convert to -40°C (5 minutes) Total 100 continuous cycles 	No damage
Humidity resistance	I / Lemperature 85+5°C.	
High temperature resistance	 Temperature: 150°C±5°C Time: 1000 hours. 	No damage
Low temperature resistance	 Temperature: -40°C±5°C Time: 1000 hours. 	No damage
Soldering heat resistance	 Solder bath temperature: 260±5°C Bathing time: 10±1 seconds 	No damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of 245±5°C for 3±1 seconds.	No damage

(2) Storage condition

(a) At warehouse:

The temperature should be within $0 \sim 30^{\circ}$ C and humidity should be less than 60% RH. The product should be used within 1 year from the time of delivery.

(b) On board:

The temperature should be within -40 ~ 85°C and humidity should be less than 85% RH.

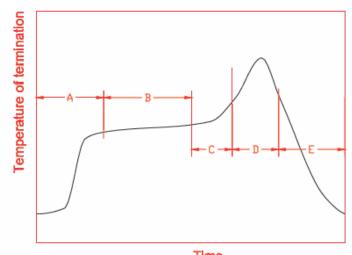
(3) Operating temperature range

Operating temperature range : -40 ~ +105°C.

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9. Recommended reflow soldering:

Reference: J-STD-020C



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Α	1 st rising temperature	The normal to Preheating temperature	30s to 60s
В	Preheating	140°C to 160°C	60s to 120s
С	2 nd rising temperature	Preheating to 200°C	20s to 40s
		if 220℃	50s∼60s
	Main heating	if 230℃	40s∼50s
D		if 240℃	30s∼40s
		if 250℃	20s~40s
		if 260°C	20s~40s
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

(1) Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

(2) Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.

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